

PATENT ABSTRACTS OF JAPAN

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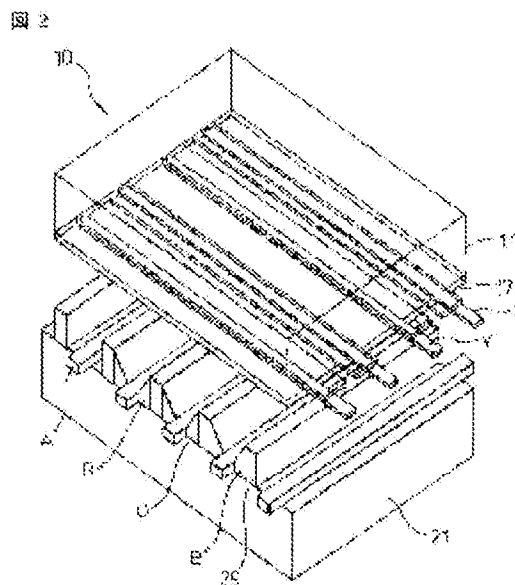
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(54) MANUFACTURING METHOD OF SUBSTRATE FOR IMAGE DISPLAY PANEL

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a manufacturing method of a substrate for an image display panel wherein ribs are not provided in the peripheral region of the panel and wherein chip-off of rib end parts can be prevented.

SOLUTION: This substrate is constituted so that a light permeating molding die provided with a recess corresponding to the rib is prepared, a rib forming material composed of a photosensitive paste is filled into the recess of the molding die, that the face filled by the photosensitive paste of the molding die is made to be abutted on the light permeating substrate, that the rib forming material containing a part selectively cured by applying light exposure to a display region of the substrate is made to be adhered to at least either one of the substrate or the forming die, and that the rib forming material including the part selectively cured is transcribed onto the substrate by peeling off the molding die from the substrate still while the rib forming material filled in the peripheral region of the panel adjacent to the display region is not cured yet.



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